# DATA SHEET

# TDA9845
## TV and VTR stereo/dual sound processor with digital identification

Preliminary specification
Supersedes data of January 1993
File under Integrated Circuits, IC02

1995 Mar 20



PHILIPS

# TV and VTR stereo/dual sound processor with digital identification

# TDA9845

## FEATURES

- Supply voltage 5 to 8 V
- Source selector
- Stereo matrix
- AF input for mono source
- AF outputs for Main
- LED operation mode indication (stereo and dual)
- High identification reliability.

## GENERAL DESCRIPTION

The TDA9845 is a stereo/dual sound processor for TV and VTR sets. Its identification ensures safe operation by using internal digital PLL technique with extremely small bandwidth, synchronous detection and digital integration (switching time maximum 2.1 s; identification concerning the main functions).

## QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|---|
| $V_P$ | supply voltage (pin 18) | | 4.5 | 5 | 8.8 | V |
| $I_P$ | supply current (pin 18) | without LED current | 12 | 13 | 16.5 | mA |
| $V_{i(rms)}$ | nominal input signal voltage ($V_{i\,1}$, $V_{i\,2}$, $V_{i\,3}$) (RMS value) | 54% modulation | | | | |
| | | B/G | – | 250 | – | mV |
| | | L (only for $V_{i\,1}$) | – | 500 | – | mV |
| $V_{o(rms)}$ | nominal output signal voltage (RMS value) | 54% modulation | – | 500 | – | mV |
| $V_{o(rms)}$ | clipping level of the output signal voltages (RMS value) | THD ≤1.5% | | | | |
| | | $V_P$ = 5 V | 1.4 | 1.6 | – | V |
| | | $V_P$ = 8 V | 2.4 | 2.65 | – | V |
| $I_{LON}$ | input current | LED ON | – | – | 12 | mA |
| $V_{i\ pil}$ | input voltage sensitivity of pilot frequency | unmodulated | 5 | – | 100 | mV |
| S/N(W) | weighted signal-to-noise ratio | *"CCIR468-3"* | 66 | 75 | – | dB |
| THD | total harmonic distortion | | – | 0.2 | 0.3 | % |
| $T_{amb}$ | operating ambient temperature range | | 0 | – | +70 | °C |
| $f_{ident}$ | identification window width | STEREO | 2.2 | – | 2.2 | Hz |
| | | DUAL | 2.3 | – | 2.3 | Hz |
| $t_{ident\ ON}$ | total identification time ON | | 0.35 | – | 2.1 | s |
| $V_{i\ tuner}$ | identification voltage sensitivity | | – | 28 | – | dBμV |
| $\Delta f_{pil}$ | pull-in frequency range of pilot PLL | $f_\omega$ = 10.008 MHz | | | | |
| | | lower side | –296 | – | –296 | Hz |
| | | upper side | 302 | – | 302 | Hz |

## ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | |
|---|---|---|---|
| | NAME | DESCRIPTION | VERSION |
| TDA9845 | DIP20 | plastic dual in-line package; 20 leads (300 mil) | SOT146-1 |
| TDA9845T | SO20 | plastic small outline package; 20 leads; body width 7.5 mm | SOT163-1 |

## BLOCK DIAGRAMS

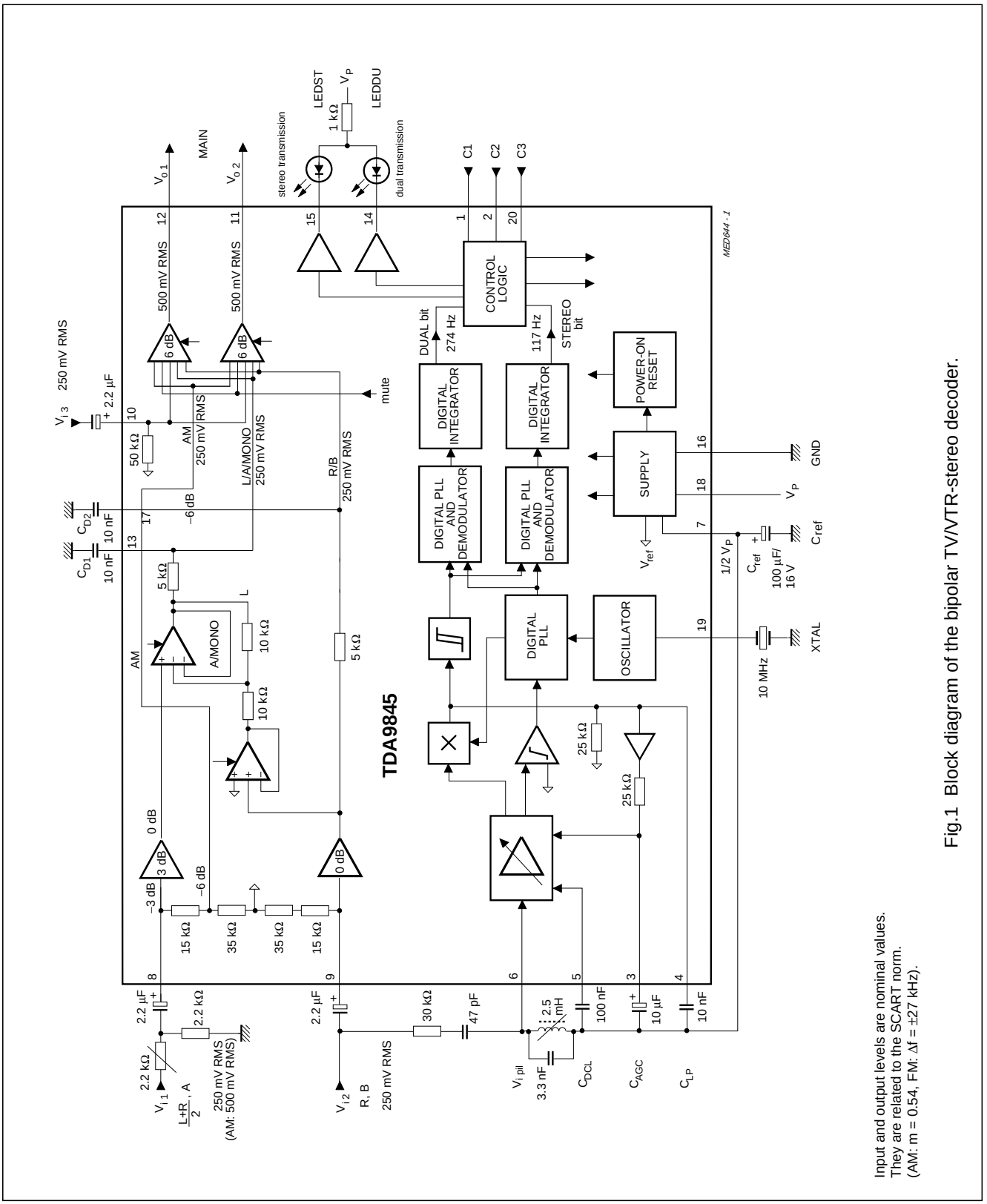
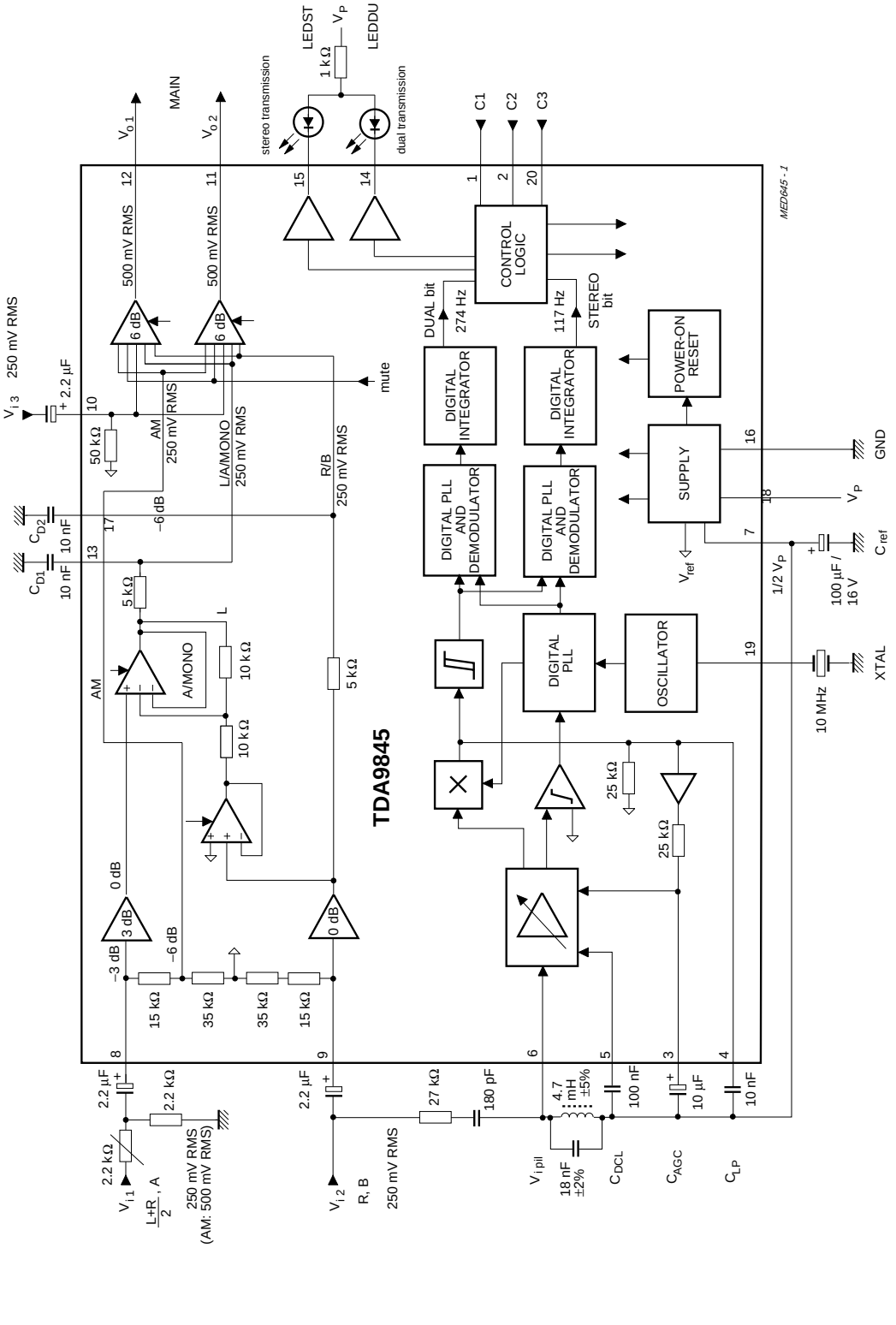



Fig.1 Block diagram of the bipolar TV/VTR-stereo decoder.

Input and output levels are nominal values. They are related to the SCART norm. (AM: m = 0.54, FM: Δf = ±27 kHz).




The components of the external LC band-pass filter have the following order-No.:
Philips Germany only No: 4312020 17525 or Fastron Sdn. Bha., Malaysia type
SMCC 472 J for L = 4.7 MHz (±5%)
Philips Components No: 2222 429 71802, C = 1.8 nF (±2%).

Input and output levels are nominal values.
They are related to the SCART norm.
(AM: m = 0.54, FM: Δf = ±27 kHz).

Fig.2 Block diagram of the bipolar TV/VTR-stereo decoder with fixed coil (alignment-free).

## PINNING

| SYMBOL | PIN | DESCRIPTION |
|---|---|---|
| C1 | 1 | control input Port C1 |
| C2 | 2 | control input Port C2 |
| $C_{AGC}$ | 3 | AGC capacitor of pilot frequency amplifier |
| $C_{LP}$ | 4 | identification low-pass capacitor |
| $C_{DCL}$ | 5 | DC loop capacitor |
| $V_{i\ pil}$ | 6 | pilot frequency input voltage |
| $C_{ref}$ | 7 | capacitor of reference voltage ($\frac{1}{2}V_P$) |
| $V_{i\ 1}$ | 8 | AF input signal voltage 1 (from sound carrier 1 or AM sound (standard L) |
| $V_{i\ 2}$ | 9 | AF input signal voltage 2 (from sound carrier 2) |
| $V_{i\ 3}$ | 10 | AF input signal voltage 3 (Mono sound) |
| $V_{o\ 2}$ | 11 | AF output signal voltage 2 (Main) |
| $V_{o\ 1}$ | 12 | AF output signal voltage 1 (Main) |
| $C_{D1}$ | 13 | 50 μs de-emphasis capacitor of AF Channel 1 |
| LEDDU | 14 | LED (dual) |
| LEDST | 15 | LED (stereo) |
| GND | 16 | ground (0 V) |
| $C_{D2}$ | 17 | 50 μs de-emphasis capacitor of AF Channel 2 |
| $V_P$ | 18 | supply voltage (+5 to +8 V) |
| XTAL | 19 | 10 MHz crystal input |
| C3 | 20 | control input Port C3 |

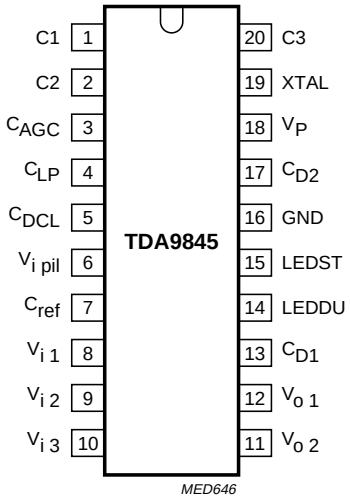



Fig.3 Pin configuration.

## FUNCTIONAL DESCRIPTION

### AF signal handling

The input AF signals, derived from the two sound carriers, are processed in analog form using operational amplifiers. Dematrixing uses the technique of two amplifiers processing the AF signals. Finally, a source selector provides the facility to route the mono signal through to the outputs ('forced mono').

De-emphasis is performed by two RC low-pass filter networks with internal resistors and external capacitors. This provides a frequency response with the tolerances given in Fig.4.

A source selector, controlled via the control input ports allows selection of the different modes of operation in accordance with the transmitted signal. The device was designed for a nominal input signal (FM: 54% modulation is equivalent to $\Delta f = \pm 27$ kHz) of 250 mV RMS ($V_{i\,1}$, $V_{i\,2}$) and for a nominal input signal (AM: m = 0.54) of 500 mV RMS ($V_{i\,1}$), respectively 250 mV RMS ($V_{i\,3}$). A nominal gain of 6 dB for $V_{i\,1}$ and $V_{i\,2}$ signals (0 dB for $V_{i\,1}$ signal (AM sound)) and 6 dB for $V_{i\,3}$ signal is built-in. By using rail-to-rail operational amplifiers, the clipping level (THD ≤1.5%) is 1.60 V RMS for $V_P$ = 5 V and 2.65 V RMS for $V_P$ = 8 V at outputs $V_{o\,1}$, $V_{o\,2}$. Care has been taken to minimize switching plops. Also total harmonic distortion and random noise are considerably reduced.

### Identification

The pilot signal is fed via an external RC high-pass filter and single tuned LC band-pass filter to the input of a gain controlled amplifier. The external LC band-pass filter in combination with the external RC high-pass filter should have a loaded Q-factor of approximately 40 to 50 to ensure the highest identification sensitivity. By using a fixed coil (±5%) to save the alignment (see Fig.2), a Q-factor of approximately 12 is proposed. This may cause a loss in sensitivity of approximately 2 to 3 dB. A digital PLL circuit generates a reference carrier, which is synchronized with the pilot carrier. This reference carrier and the gain controlled pilot signal are fed to the AM-synchronous demodulator. The demodulator detects the identification signal, which is fed through a low-pass filter with external capacitor $C_{LP}$ (pin 4) to a Schmitt-trigger for pulse shaping and suppression of low level spurious signal components. This is a measure against mis-identification.

The identification signal is amplified and fed through an AGC low-pass filter with external capacitor $C_{AGC}$ (pin 3) to obtain the AGC voltage for controlling the gain of the pilot signal amplifier.

The identification stages consist of two digital PLL circuits with digital synchronous demodulation and digital integrators to generate the stereo or dual sound identification bits which can be indicated via LEDs.

A 10 MHz crystal oscillator provides the reference clock frequency. The corresponding detection bandwidth is larger than ±50 Hz for the pilot carrier signal, so that $f_p$-variations from the transmitter can be tracked in the event of missing synchronization with the horizontal frequency $f_H$. However the detection bandwidth for the identification signal is made small (±1 Hz) to reduce mis-identification.

Figure 2 shows an example of the alignment-free $f_p$ band-pass filter. To achieve the required $Q_L$ of around 12, the $Q_0$ at $f_p$ of the coil was chosen to be around 25 (effective $Q_0$ including PCB influence). Using coils with other $Q_0$, the RC-network ($R_{FP}$, $C_{FP}$) has to be adapted accordingly. It is assumed that the loss factor tanδ of the resonance capacitor is ≤0.01 at $f_p$.

Copper areas under the coil might influence the loaded Q and have to be taken into account. Care has also to be taken in environments with strong magnetic fields when using coils without magnetic shielding.

### Control input ports

The complete IC is controlled by the three control input ports C1, C2 and C3 (TTL-level). With these ports the user can select between different AF sources according to the transmitter status (see Table 1). Finally Schmitt-triggers are added in the input port interfaces to suppress spikes from the control lines C1, C2 and C3.

After a power-on reset, the logic is reset (mute mode for the AF channel). After some time (≤1 ms), when the power-on reset is automatically deactivated, the switch position of the Main channel is changed according to the control input port levels C1, C2 and C3.

For standard L, the AM sound is fed via the AF input ($V_{i\,1}$) to the two AF outputs ($V_{o\,1}$,$V_{o\,2}$). This can also be achieved by feeding at AF input $V_{i\,3}$.

The logic level combination 111 of the control input ports (C3, C2 and C1) is **not allowed** (see Table 1).

### Power supply

The different supply voltages and currents required for the analog and digital circuits are derived from an internal band-gap reference circuit. The AF reference voltage is $\frac{1}{2}V_P$. For a fast setting to $\frac{1}{2}V_P$ an internal start-up circuit is added. A good ripple rejection is achieved with the external capacitor $C_{ref}$ = 100 µF/16 V in conjunction with the high ohmic input of the $\frac{1}{2}V_P$ pin (pin 7). No additional DC load on this pin is allowed.

### Power-on reset

When a power-on reset is activated by switching on the supply voltage or because of a supply voltage breakdown, the 117/274 Hz DPLL, the 117/274 Hz integrator and the logic will be reset. The AF channel (Main) is muted (≤1 ms).

### ESD protection

All pins are ESD protected. The protection circuits represent the latest state of the art.

### Internal circuit

The internal pin loading diagram is given in Fig.7.

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|---|---|---|---|---|---|
| $V_P$ | supply voltage (pin 18) | | –0.3 | 10 | V |
| $V_i$ | voltage at pins 1, 2 and 20 | | –0.3 | 9.0 | V |
| $V_i$ | voltage at pins 3 to 13, 17 and 19 | | –0.3 | $V_P$ | V |
| $V_i$ | voltage at pins 14 and 15 | | –0.3 | 10 | V |
| $T_{stg}$ | storage temperature | | –25 | +150 | °C |
| $T_{amb}$ | operating ambient temperature | | 0 | +70 | °C |
| $V_{esd}$ | electrostatic handling for all pins | note 1 | –500 | +500 | V |

**Note**

1. Charge device model class A: discharging a 200 pF capacitor through a Ω series resistor.

## THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | VALUE | UNIT |
|---|---|---|---|
| $R_{th\ j\text{-}a}$ | thermal resistance from junction to ambient in free air | | |
| | DIP20 | 73 | K/W |
| | SO20 | 90 | K/W |

## CHARACTERISTICS

$V_P$ = 5 V; $T_{amb}$ = +25 °C; nominal input signal $V_{i\,1,\,2}$ = 0.25 V RMS value (FM: 54% modulation is equivalent to $\Delta f = \pm 27$ kHz); nominal input signal $V_{i\,1}$ = 0.5 V RMS value (AM: m = 0.54); nominal input signal $V_{i\,3}$ = 0.25 V RMS value (AM: m = 0.54); nominal output signal $V_{o\,1,\,2}$ = 0.5 V RMS value; $f_{AF}$ = 1 kHz; $V_{i\,pil}$ = 16 mV RMS value; $f_{pil}$ = 54.6875 kHz (identification frequencies: stereo = 117.48 Hz, dual = 274.12 Hz), 50 µs pre-emphasis; noise measurement in accordance with *"CCIR468-3"*, working oscillator frequency $f_\omega$ = 10008 MHz; currents into the IC positive; measured in test circuit Fig.5 unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|---|
| **Supply** | | | | | | |
| $V_P$ | supply voltage (pin 18) | | 4.5 | 5 | 8.8 | V |
| $I_P$ | supply current (pin 18) | without LED current | 12 | 13 | 16.5 | mA |
| $P_{tot}$ | total power dissipation | | 54 | 65 | 145.2 | mW |
| $V_{n(DC)}$ | DC voltage (pins 8 to 13 and 17) | | $\frac{1}{2}V_P - 0.1$ | $\frac{1}{2}V_P$ | $\frac{1}{2}V_P + 0.1$ | V |
| $V_{ref(DC)}$ | DC reference voltage (pin 7) | | $\frac{1}{2}V_P - 0.1$ | $\frac{1}{2}V_P$ | $\frac{1}{2}V_P + 0.1$ | V |
| $I_{L(DC)}$ | DC leakage current (pin 7) | | – | – | ±1 | µA |
| **AF Inputs; $V_{i\,1}$ and $V_{i\,2}$ (pins 8 and 9)** | | | | | | |
| $V_{i(rms)}$ | nominal input signal voltage (RMS value) | 54% modulation | | | | |
| | | B/G | – | 0.25 | – | V |
| | | L (only $V_{i\,1}$) | – | 0.5 | – | V |
| $V_{i(rms)}$ | clipping voltage level (RMS value) | THD ≤ 1.5% | | | | |
| | | $V_P$ = 5 V; B/G | 0.625 | 0.715 | – | V |
| | | $V_P$ = 8 V; B/G | 1.050 | 1.200 | – | V |
| | | $V_P$ = 5 V; L (only $V_{i\,1}$) | 1.200 | 1.600 | – | V |
| | | $V_P$ = 8 V; L (only $V_{i\,1}$) | 2.100 | 2.356 | – | V |
| $G_v$ | AF signal voltage gain | $G = V_o/V_i$; note 1 | | | | |
| | | B/G | 5 | 6 | 7 | dB |
| | | L (only $V_{i\,1}$) | –1 | 0 | +1 | dB |
| $R_i$ | input resistance | | 40 | 50 | 60 | kΩ |
| $R_{deem}$ | internal de-emphasis resistor (pins 13 and 17) | see Fig.4 | 4.25 | 5.0 | 5.75 | kΩ |
| **Additional AF input pin (pin 10)** | | | | | | |
| $V_{i(rms)}$ | nominal input signal voltage (RMS value) | 54% modulation | – | 0.25 | – | V |
| $V_{i(rms)}$ | clipping voltage level (RMS value) | THD ≤ 1.5% | | | | |
| | | $V_P$ = 5 V | 0.625 | 0.715 | – | V |
| | | $V_P$ = 8 V | 1.050 | 1.200 | | V |
| $G_v$ | AF signal voltage gain | $G = V_o/V_i$; note 1 | 5 | 6 | 7 | dB |
| $R_i$ | input resistance | | 40 | 50 | 60 | kΩ |

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|---|
| **AF outputs (pins 11 and 12)** | | | | | | |
| $V_{o(rms)}$ | nominal output signal voltage (RMS value) | THD ≤ 0.3%; 54% modulation | – | 0.5 | – | V |
| $V_{o(rms)}$ | clipping voltage level (RMS value) | THD ≤ 1.5% | | | | |
| | | $V_P$ = 5 V | 1.4 | 1.6 | – | V |
| | | $V_P$ = 8 V | 2.4 | 2.65 | – | V |
| $R_o$ | output resistance | | 150 | 250 | 350 | Ω |
| $C_L$ | load capacitor on output | | – | – | 1.5 | nF |
| $R_L$ | load resistor on output (AC-coupled) | | 10 | – | – | kΩ |
| B | frequency response (bandwidth) | $f_i$ = 40 to 20000 Hz; note 2 | –0.5 | – | +0.5 | dB |
| $B_{-3\ dB}$ | frequency response | –3 dB; note 2 | 300 | 350 | 400 | kHz |
| THD | total harmonic distortion | note 1 | – | 0.2 | 0.3 | % |
| S/N(W) | weighted signal-to-noise ratio | *"CCIR468-3"* (quasi-peak) | 66 | 75 | – | dB |
| $\alpha_{cr}$ | crosstalk attenuation for | notes 1 and 3 | | | | |
| | DUAL | $\lvert Z_s \rvert \leq 1$ kΩ | 70 | 75 | – | dB |
| | STEREO | $\lvert Z_s \rvert \leq 1$ kΩ | 40 | 45 | – | dB |
| $\alpha_{mute}$ | mute attenuation | $\lvert Z_s \rvert \leq 1$ kΩ; note 1 | 76 | 80 | – | dB |
| $\Delta V_{DC}$ | change of DC level output voltage between any two modes of operation | after switching | – | – | ±10 | mV |
| PSRR | power supply ripple rejection | $f_r$ = 70 Hz; see Fig.6 | 50 | 65 | – | dB |
| $I_{O(DC)}$ | DC output current | | – | – | ±20 | μA |
| **10 MHz crystal oscillator (pin 19)** | | | | | | |
| $f_r$ | series resonant frequency of crystal (fundamental mode) | $C_L$ = 20 pF | 9.995 | 10.008 | 10.021 | MHz |
| $f_\omega$ | working oscillator frequency (running in parallel resonance mode) | over operating temperature range including ageing and influence of drive circuit | 9.988 | 10.008 | 10.028 | MHz |
| $R_r$ | equivalent crystal series resistance | even at extremely low drive level (<1 pW) over operating temperature range with $C_0$ = 6 pF | – | 60 | 200 | Ω |
| $R_n$ | crystal series resistance of unwanted mode | | $2 \times R_r$ | – | – | Ω |
| $C_0$ | crystal parallel capacitance | with $R_r \leq 100$ Ω | – | 6 | 10 | pF |
| $C_1$ | crystal motional capacitance | | – | 25 | 50 | fF |
| $P_{XTAL}$ | level of drive in operation | | – | – | 5 | μW |
| $V_{OSC(p-p)}$ | oscillator operating voltage (peak-to-peak value) | | 500 | 550 | 600 | mV |

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|---|
| **Pilot processing** | | | | | | |
| $V_{i\ pil(rms)}$ | pilot input voltage level at pin 6 (RMS value) | unmodulated | 5 | – | 100 | mV |
| $R_{i\ pil}$ | pilot input resistance | | 500 | 1000 | – | kΩ |
| $C_{i\ pil}$ | pilot input capacitance | | – | – | 3 | pF |
| m | modulation depth | AM | 25 | 50 | 75 | % |
| $\Delta f_{pil}$ | pilot PLL pull-in frequency range (referenced to $f_{pil}$ = 54.6875 kHz) | $f_\omega$ = 9.988 MHz | | | | |
| | | lower side | –405 | – | –405 | Hz |
| | | upper side | 192 | – | 192 | Hz |
| | | $f_\omega$ = 10.008 MHz | | | | |
| | | lower side | –296 | – | –296 | Hz |
| | | upper side | 302 | – | 302 | Hz |
| | | $f_\omega$ = 10.028 MHz | | | | |
| | | lower side | –188 | – | –188 | Hz |
| | | upper side | 411 | – | 411 | Hz |
| $t_{pil}$ | pilot PLL pull-in time | | 0 | – | 1.7 | ms |
| $f_{LP}$ | low-pass frequency response | –3 dB | 450 | 600 | 750 | Hz |
| $R_4$ | low-pass output resistance | | 18.75 | 25 | 31.25 | kΩ |
| $V_{4(rms)}$ | identification threshold voltage (RMS value) | | – | – | 70 | mV |
| $Q_L$ | loaded quality factor of resonance circuit | HIGH sensitivity; see Fig.1 | 40 | – | 50 | |
| | loaded quality factor of resonance circuit with fixed coil | sensitivity loss 2 to 3 dB; see Fig.2 | – | 12 | – | |
| $t_{acqui\ AGC}$ | AGC acquisition time | $V_{i\ pil(rms)}$ switched from 0 to 100 mV RMS value | – | – | 0.1 | s |
| **Identification (internal functions)** | | | | | | |
| $V_{i\ tuner}$ | identification voltage sensitivity | note 4 | – | 28 | – | dBμV |
| C/N | pilot carrier-to-noise ratio for start of identification | note 5 | – | 33 | – | dB/Hz |
| H | hysteresis | note 4 | – | – | 2 | dB |
| $f_{det}$ | pull-in frequency range of identification PLL (referenced to $f_{det\ STEREO}$ = 117.48 Hz and $f_{det\ DUAL}$ = 274.12 Hz) | lower side | | | | |
| | | STEREO | –0.63 | – | –0.63 | Hz |
| | | DUAL | –0.69 | – | –0.69 | Hz |
| | | upper side | | | | |
| | | STEREO | 0.63 | – | 0.63 | Hz |
| | | DUAL | 0.69 | – | 0.69 | Hz |

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|---|
| $t_{det}$ | pull-in time of identification PLL (referenced to $f_{det\ STEREO}$ = 117.48 Hz and $f_{det\ DUAL}$ = 274.12 Hz) | STEREO | 0 | – | 0.8 | s |
| | | DUAL | 0 | – | 0.8 | s |
| $f_{ident}$ | identification window frequency width (referenced to $f_{det\ STEREO}$ = 117.48 Hz and $f_{det\ DUAL}$ = 274.12 Hz) | STEREO; note 6 | 2.2 | – | 2.2 | Hz |
| | | DUAL; note 6 | 2.3 | – | 2.3 | Hz |
| $t_{integr}$ | integrator time constant | | 0.94 | – | 0.94 | s |
| $t_{ident(on)}$ | total identification time on | STEREO; note 7 | 0.35 | – | 2.0 | s |
| | | DUAL; note 7 | 0.35 | – | 2.0 | s |
| $t_{ident(off)}$ | total identification time off | STEREO; note 8 | 0.60 | – | 1.5 | s |
| | | DUAL; note 8 | 0.60 | – | 1.5 | s |
| **LED (pins 14 and 15)** | | | | | | |
| $V_{L(off)}$ | output voltage | LED off | – | – | 8.8 | V |
| $V_{L(on)}$ | output voltage | LED on | – | – | 0.7 | V |
| $I_{L(off)}$ | input current | LED off | – | – | 1 | µA |
| $I_{L(on)}$ | input current | LED on | – | – | 12 | mA |
| **Control input ports C1, C2 and C3 (pins 1, 2 and 20)** | | | | | | |
| $V_{CL}$ | LOW level input voltage | | 0 | – | 0.8 | V |
| $V_{CH}$ | HIGH level input voltage | | 2.4 | – | 8.8 | V |
| $I_{CL}$ | LOW level input current | | – | – | –1 | µA |
| $I_{CH}$ | HIGH level input current | | – | – | 1 | µA |

**Notes**

1. $V_o$ = 0.5 V RMS value; f = 1 kHz.
2. Without de-emphasis capacitors with respect to nominal gain.
3. In dual mode: A (B)-signal into B (A) channel.
   In stereo mode: R-signal into left channel; L-signal = 0.
4. Tuner input signal, measured with PCALH reference front end (½EMF, 75 Ω, 2T/20T/white bar, 100% video) and $PC/SC_1$ = 13 dB; $PC/SC_2$ = 20 dB. The pilot band-pass has to be aligned.
5. Bandwidth of the pilot BP-filter $B_{-3\ dB}$ = 1.2 kHz. $V_{i\ 2}$ input driven with identification-modulated pilot carrier and white noise.
6. Identification window is defined as twice the pull-in frequency range (lower plus upper side) of identification PLL (steady detection) plus window increase due to integrator (fluctuating detection).
7. The maximum total system identification time ON is equal to $t_{ident(on)}$ plus $t_{acqui\ AGC}$.
8. The maximum total system identification time OFF is equal to $t_{ident(off)}$.

**Table 1** Control input port matrix to select AF inputs and AF outputs

| INPUT/OUTPUT | MODE | INPUT SIGNAL | | | OUTPUT SIGNAL | | CONTROL INPUT | | | LED | |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | ST/DS/M | | EXT | MAIN | | PORT(1) | | | | |
| | | $V_{i\,1}$ PIN 8 | $V_{i\,2}$ PIN 9 | $V_{i\,3}$ PIN 10 | $V_{o\,1}$ PIN 12 | $V_{o\,2}$ PIN 11 | C3 PIN 20 | C2 PIN 2 | C1 PIN 1 | DUAL PIN 14 | STEREO PIN 15 |
| Mute; note 2 | – | – | – | – | no signal | | 0 | 0 | 0 | OFF | OFF |
| Sound mute | – | – | – | – | no signal | | 1 | 0 | 0 | note 3 | note 3 |
| Mono | M | M | – | – | M | M | 0 | 0 | 1 | OFF | OFF |
| | | M | – | – | M | M | 0 | 1 | 0 | OFF | OFF |
| | | AM | – | – | AM | AM | 0 | 1 | 1 | OFF | OFF |
| Stereo | ST | S | R | – | L | R | 0 | 0 | 1 | OFF | ON |
| | | S | R | – | S | S | 0 | 1 | 0 | OFF | ON |
| | | S | R | – | S | S | 0 | 1 | 1 | OFF | ON |
| Dual | DS | A | B | – | A | B | 0 | 0 | 1 | ON | OFF |
| | | A | B | – | A | A | 0 | 1 | 0 | ON | OFF |
| | | A | B | – | B | B | 0 | 1 | 1 | ON | OFF |
| External; note 4 | – | – | – | C | C | C | 1 | 0 | 1 | note 3 | note 3 |
| | | – | – | C | C | C | 1 | 1 | 0 | OFF | OFF |

**Notes**

1. The combination 111 is **not allowed**.
2. In mute mode the content of the 117 Hz/274 Hz integrator will be reset. The LEDs are switched OFF.
3. The LED show the identification status.
4. In external mode, in the combination 110 only the LEDs are switched OFF.

**Table 2** Explanation of Table 1

| SIGNAL | DESCRIPTION |
|---|---|
| R | right |
| L | left |
| S | $\frac{(L+R)}{2}$ |
| A and B | dual sound A/B |
| C | external sound source |
| AM | AM sound (standard L) |
| M | mono sound |
| DS | dual sound |
| ST | stereo sound |

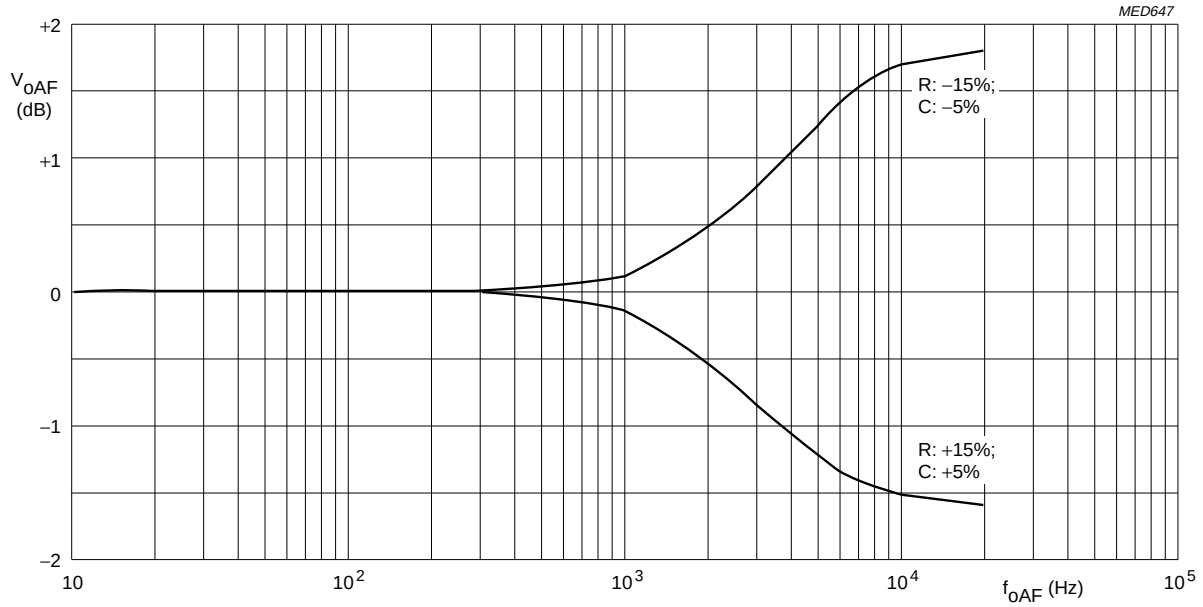



Fig.4 Tolerance scheme of AF frequency response; de-emphasis with $C_{D1}$, $C_{D2}$ = 10 nF (±5%), $R_{internal}$ = 5 kΩ (±15%).

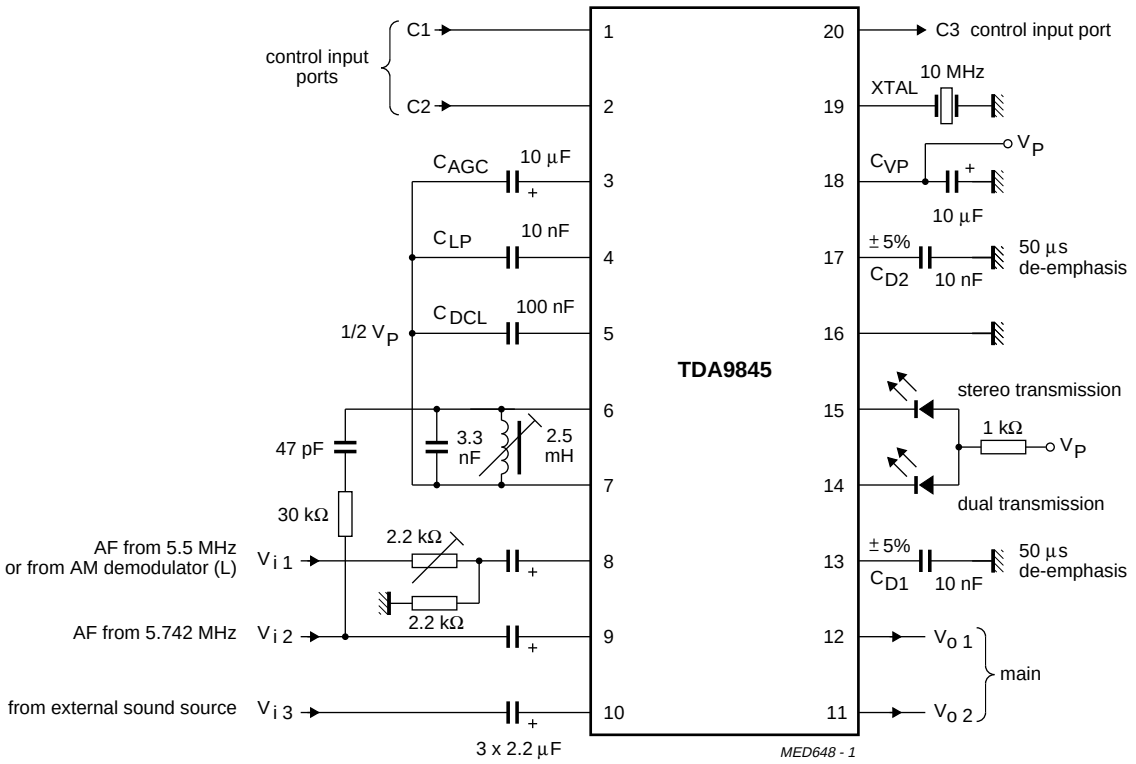



Fig.5 Test circuit of the stereo decoder TDA9845.

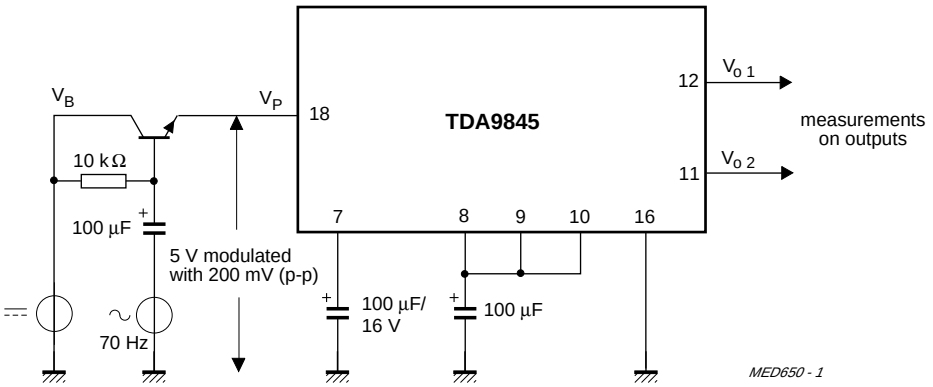



Fig.6 Test circuit for measurement of ripple rejection.

## INTERNAL CIRCUITRY

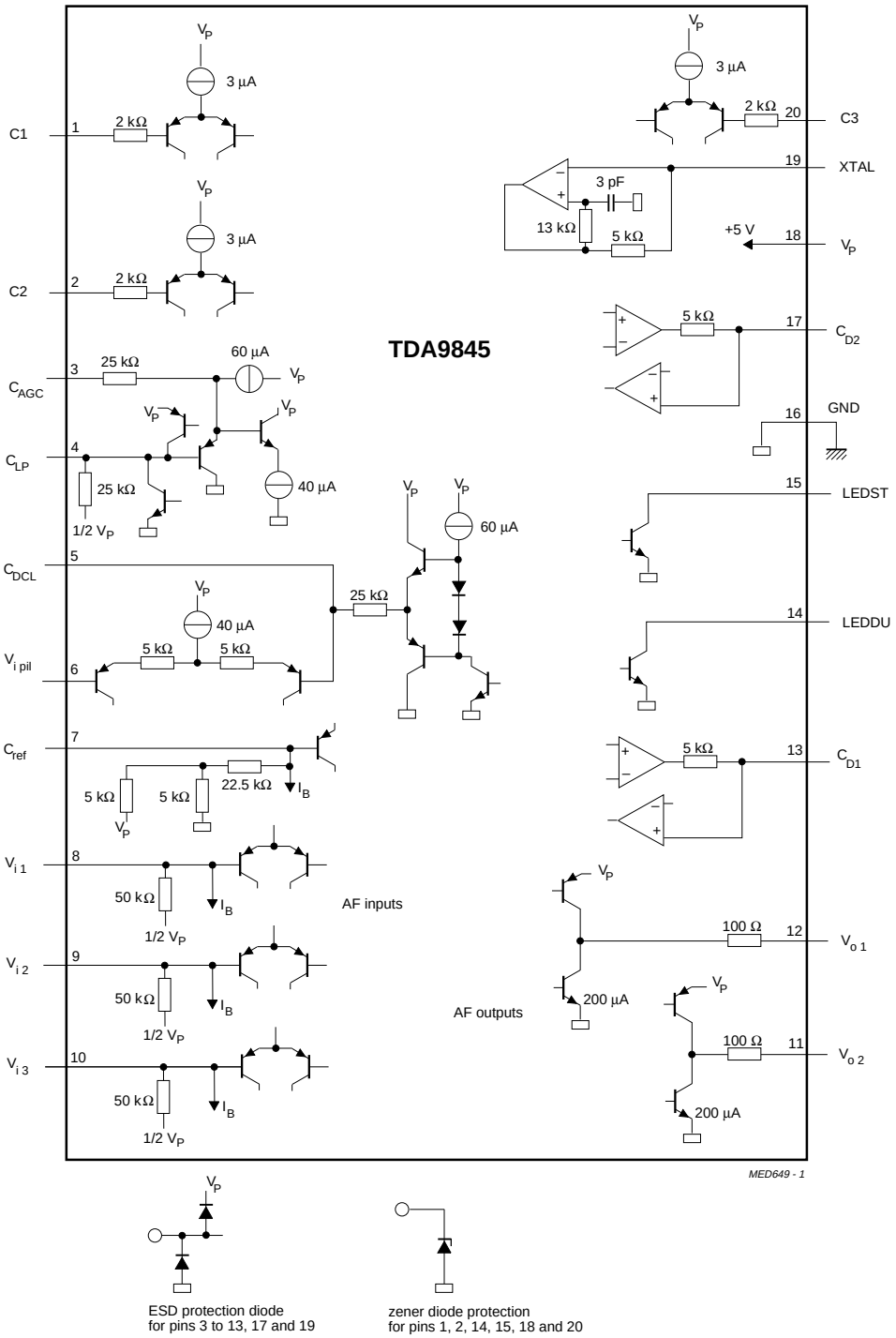
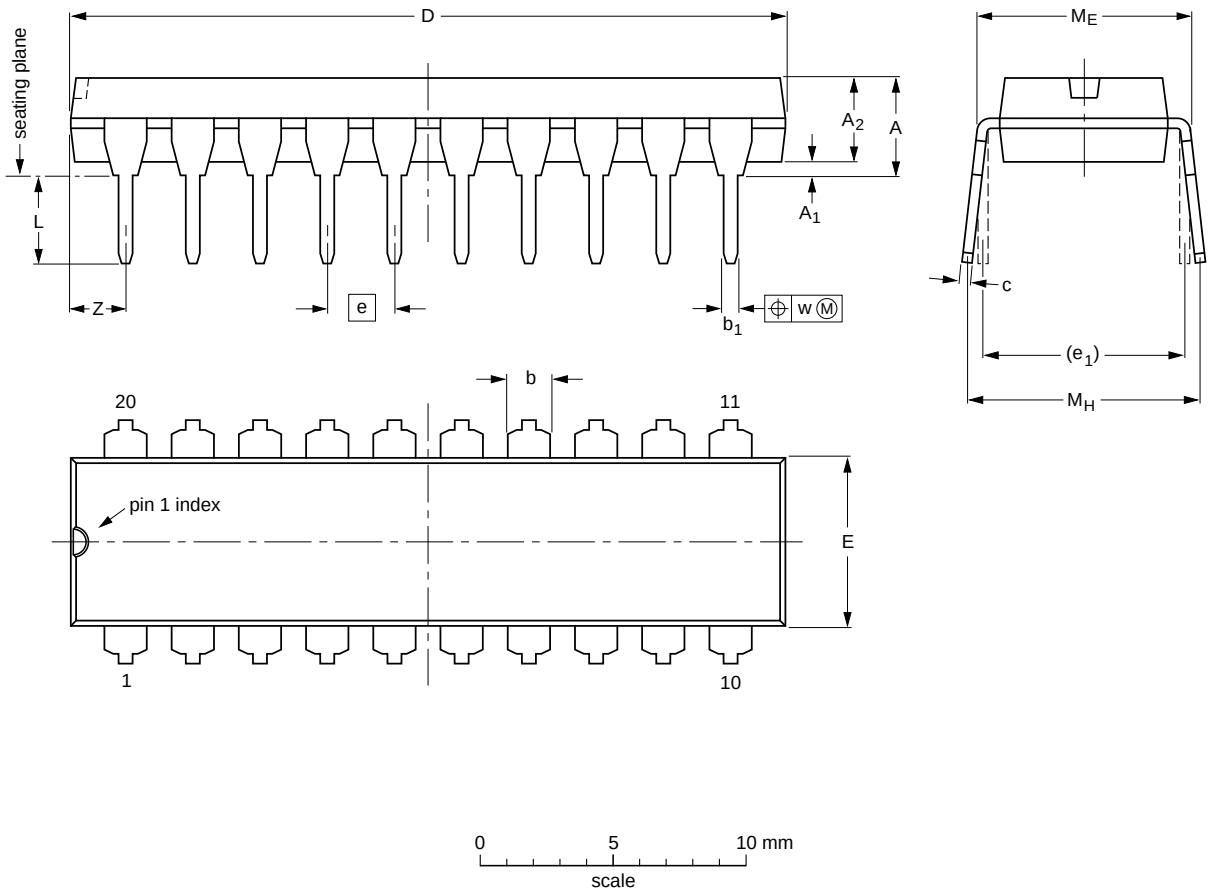



Fig.7 Internal circuitry.

## PACKAGE OUTLINES

**DIP20: plastic dual in-line package; 20 leads (300 mil)** **SOT146-1**




**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

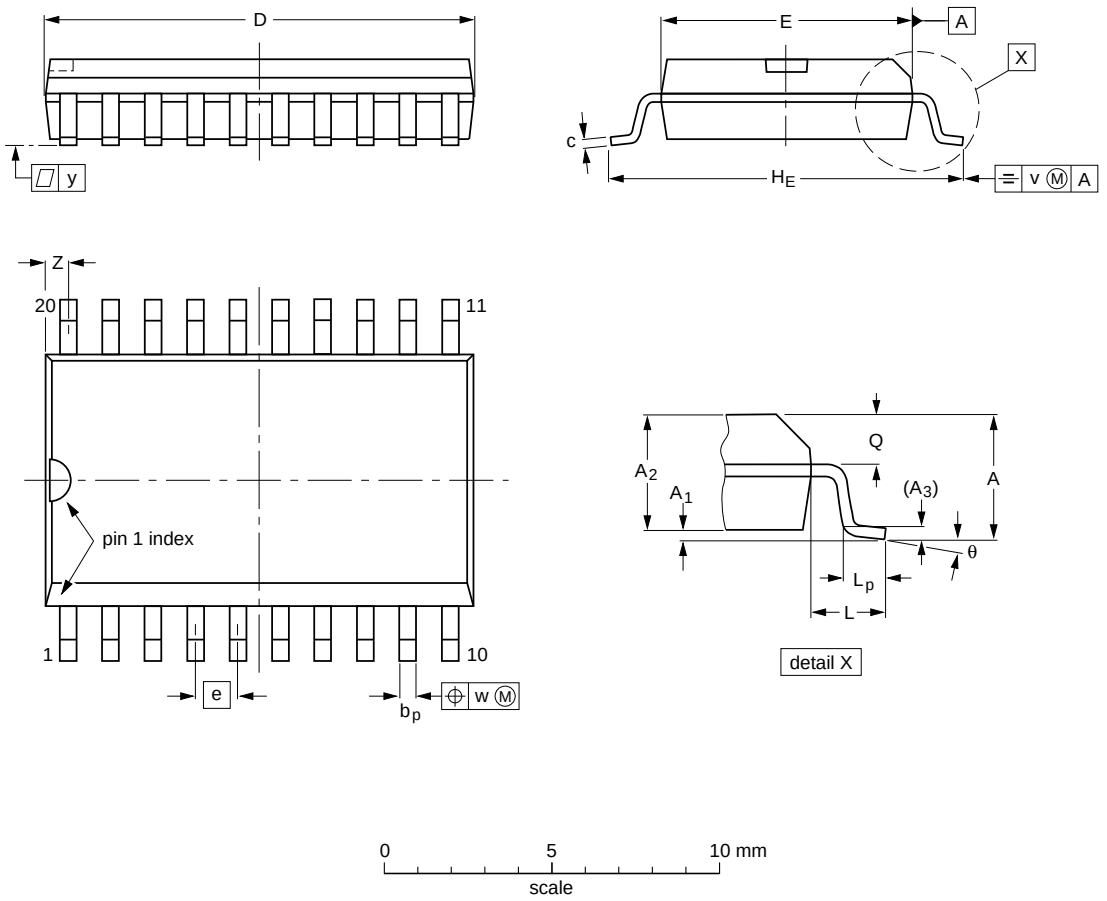
| UNIT | A max. | $A_1$ min. | $A_2$ max. | b | $b_1$ | c | D (1) | E (1) | e | $e_1$ | L | $M_E$ | $M_H$ | w | Z (1) max. |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 4.2 | 0.51 | 3.2 | 1.73<br>1.30 | 0.53<br>0.38 | 0.36<br>0.23 | 26.92<br>26.54 | 6.40<br>6.22 | 2.54 | 7.62 | 3.60<br>3.05 | 8.25<br>7.80 | 10.0<br>8.3 | 0.254 | 2.0 |
| inches | 0.17 | 0.020 | 0.13 | 0.068<br>0.051 | 0.021<br>0.015 | 0.014<br>0.009 | 1.060<br>1.045 | 0.25<br>0.24 | 0.10 | 0.30 | 0.14<br>0.12 | 0.32<br>0.31 | 0.39<br>0.33 | 0.01 | 0.078 |

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | EIAJ | | | |
| SOT146-1 | | | SC603 | | | ~~92-11-17~~<br>95-05-24 |

**SO20: plastic small outline package; 20 leads; body width 7.5 mm** **SOT163-1**




**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

| UNIT | A max. | $A_1$ | $A_2$ | $A_3$ | $b_p$ | c | D (1) | E (1) | e | $H_E$ | L | $L_p$ | Q | v | w | y | Z (1) | θ |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 2.65 | 0.30<br>0.10 | 2.45<br>2.25 | 0.25 | 0.49<br>0.36 | 0.32<br>0.23 | 13.0<br>12.6 | 7.6<br>7.4 | 1.27 | 10.65<br>10.00 | 1.4 | 1.1<br>0.4 | 1.1<br>1.0 | 0.25 | 0.25 | 0.1 | 0.9<br>0.4 | $8^o$<br>$0^o$ |
| inches | 0.10 | 0.012<br>0.004 | 0.096<br>0.089 | 0.01 | 0.019<br>0.014 | 0.013<br>0.009 | 0.51<br>0.49 | 0.30<br>0.29 | 0.050 | 0.42<br>0.39 | 0.055 | 0.043<br>0.016 | 0.043<br>0.039 | 0.01 | 0.01 | 0.004 | 0.035<br>0.016 | |

**Note**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | EIAJ | | | |
| SOT163-1 | 075E04 | MS-013AC | | | | ~~92-11-17~~<br>95-01-24 |

## SOLDERING

### Plastic dual in-line packages

BY DIP OR WAVE

The maximum permissible temperature of the solder is 260 °C; this temperature must not be in contact with the joint for more than 5 s. The total contact time of successive solder waves must not exceed 5 s.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply a low voltage soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C, it must not be in contact for more than 10 s; if between 300 and 400 °C, for not more than 5 s.

### Plastic small outline packages

BY WAVE

During placement and before soldering, the component must be fixed with a droplet of adhesive. After curing the adhesive, the component can be soldered. The adhesive can be applied by screen printing, pin transfer or syringe dispensing.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder bath is 10 s, if allowed to cool to less than 150 °C within 6 s. Typical dwell time is 4 s at 250 °C.

A modified wave soldering technique is recommended using two solder waves (dual-wave), in which a turbulent wave with high upward pressure is followed by a smooth laminar wave. Using a mildly-activated flux eliminates the need for removal of corrosive residues in most applications.

BY SOLDER PASTE REFLOW

Reflow soldering requires the solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the substrate by screen printing, stencilling or pressure-syringe dispensing before device placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt, infrared, and vapour-phase reflow. Dwell times vary between 50 and 300 s according to method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 min at 45 °C.

REPAIRING SOLDERED JOINTS (BY HAND-HELD SOLDERING IRON 4OR PULSE-HEATED SOLDER TOOL)

Fix the component by first soldering two, diagonally opposite, end pins. Apply the heating tool to the flat part of the pin only. Contact time must be limited to 10 s at up to 300 °C. When using proper tools, all other pins can be soldered in one operation within 2 to 5 s at between 270 and 320 °C. (Pulse-heated soldering is not recommended for SO packages.)

For pulse-heated solder tool (resistance) soldering of VSO packages, solder is applied to the substrate by dipping or by an extra thick tin/lead plating before package placement.

## DEFINITIONS

| **Data sheet status** | |
|---|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| **Limiting values** | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| **Application information** | |
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